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RAD-TOLERANT CLASS V OCTAL BUS TRANSCEIVER AND REGISTER WITH 3-STATE OUTPUTS

FEATURES

- Operates From 1.65 V to 3.6 V
- Inputs Accept Voltages to 5.5 V
- Max t_{pd} of 7.4 ns at 3.3 V
- Typical V_{OLP} (Output Ground Bounce)
 <0.8 at V_{CC} = 3.3 V, T_A = 25°C
- Typical V_{OHV} (Output V_{OH} Undershoot)
 2 V at V_{CC} = 3.3 V, T_A = 25°C
- Supports Mixed-Mode Signal Operation on All Ports (5-V Input/Output Voltage With 3.3-V V_{CC})
- I_{off} Supports Partial Power-Down-Mode Operation
- Latch-Up Performance Exceeds 250 mA Per JESD 17
- ESD Protection Exceeds JESD 22
 - 2000-V Human-Body Model (A114-A)
 - 200-V Machine Model (A115-A)
 - 1000-V Charged-Device Model (C101)
- Rad Tolerant: 50kRad (Si) TID (1)
 - TID Dose Rate 0.10 rad/s
- QML-V Qualified, SMD 5962-97626
- Radiation tolerance is a typical value based upon initial device qualification. Radiation Lot Acceptance Testing is available – contact factory for details.

W PACKAGE (TOP VIEW) CLKAB ∏ 24 V_{CC} SAB [23 CLKBA DIR [SBA 3 22∏ 21 OE A1 A2 [20 B1 5 АЗ П 19∏ B2 6 18**∏** B3 A4 [] 17 B4 A5 🛮 8 A6 9 16∏ B5 Α7 15∏ B6 10 14 B7 А8 П 11 B8 GND II 12 13**|**|

DESCRIPTION/ORDERING INFORMATION

The SN54LVC646A octal bus transceiver and register is designed for 2.7-V to 3.6-V V_{CC} operation.

This device consists of bus-transceiver circuits, D-type flip-flops, and control circuitry arranged for multiplexed transmission of data directly from the input bus or from the internal registers. Data on the A or B bus is clocked into the registers on the low-to-high transition of the appropriate clock (CLKAB or CLKBA) input. Figure 1 shows the four fundamental bus-management functions that are performed with the SN54LVC646A device.

ORDERING INFORMATION

T _A	PACKA	GE ⁽¹⁾⁽²⁾	ORDERABLE PART NUMBER	TOP-SIDE MARKING	
-55°C to 125°C	CFP – W	Tube of 85	5962-9762601VKA	5962-9762601VKA	

- For the most current package and ordering information, see the Package Option Addendum at the end of this document, or see the TI
 website at www.ti.com.
- (2) Package drawings, thermal data, and symbolization are available at www.ti.com/packaging.



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DESCRIPTION/ORDERING INFORMATION (CONTINUED)

Output-enable (\overline{OE}) and direction-control (DIR) inputs control the transceiver functions. In the transceiver mode, data present at the high-impedance port is stored in either register or in both.

The select-control (SAB and SBA) inputs <u>can</u> multiplex stored and real-time (transparent mode) data. DIR determines which bus receives data when <u>OE</u> is low. In the isolation mode (<u>OE</u> high), A data is stored in one register and B data can be stored in the other register.

When an output function is disabled, the input function still is enabled and can be used to store and transmit data. Only one of the two buses, A or B, can be driven at a time.

Inputs can be driven from either 3.3-V or 5-V devices. This feature allows the use of this device as a translator in a mixed 3.3-V/5-V system environment.

This device is fully specified for partial-power-down applications using I_{off}. The I_{off} circuitry disables the outputs, preventing damaging current backflow through the device when it is powered down.

To ensure the high-impedance state during power up or power down, \overline{OE} should be tied to V_{CC} through a pullup resistor; the minimum value of the resistor is determined by the current-sinking capability of the driver.

FUNCTION TABLE

		INP	UTS			DAT	A I/O	OPERATION OR
ŌĒ	DIR	CLKAB	CLKBA	SAB	SBA	A1-A8	B1-B8	FUNCTION
X	Х	1	Х	Х	Х	Input Unspecified ⁽¹⁾		Store A, B unspecified ⁽¹⁾
X	Χ	Χ	↑	Χ	X	Unspecified ⁽¹⁾	Input	Store B, A unspecified ⁽¹⁾
Н	Х	1	1	Х	Х	Input	Input	Store and B data
Н	Χ	H or L	H or L	X	X	Input disabled	Input disabled	Isolation, hold storage
L	L	Χ	Χ	Х	L	Output	Input	Real-time B data to A bus
L	L	Χ	H or L	X	Н	Output	Input	Stored B data to A bus
L	Н	Х	Х	L	Х	Input	Output	Real-time A data to B bus
L	Н	H or L	Χ	Н	X	Input	Output	Stored A data to B bus

⁽¹⁾ The data-output functions can be enabled or disabled by various signals at $\overline{\text{OE}}$ and DIR. Data-input functions always are enabled; i.e., data at the bus terminals is stored on every low-to-high transition of the clock inputs.

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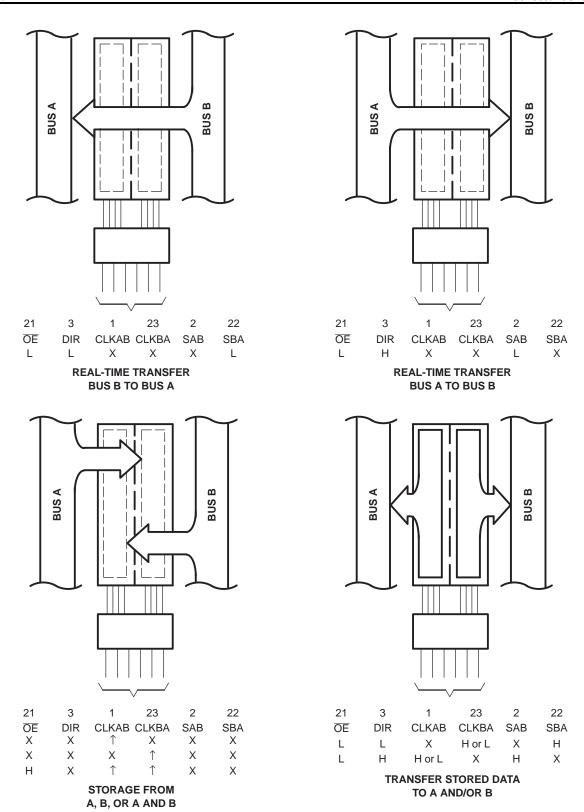
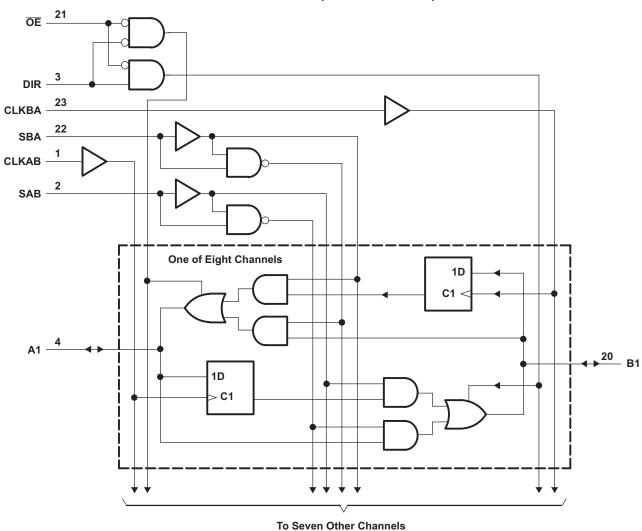


Figure 1. Bus-Management Functions

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LOGIC DIAGRAM (POSITIVE LOGIC)



Absolute Maximum Ratings(1)

over operating free-air temperature range (unless otherwise noted)

				MIN	MAX	UNIT
V _{CC}	Supply voltage range			-0.5	6.5	V
VI	Input voltage range (2)			-0.5	6.5	V
Vo	Voltage range applied to any output in the high-impedance or power-off state ⁽²⁾		-0.5	6.5	V	
Vo	Voltage range applied to any output in the high or low state (2)(3)			-0.5	$V_{CC} + 0.5$	V
I _{IK}	Input clamp current	V _I < 0			-50	mA
I _{OK}	Output clamp current	V _O < 0			-50	mA
IO	Continuous output current				±50	mA
	Continuous current through V _{CC} or GND				±100	mA
T _{stg}	Storage temperature range			-65	150	°C

⁽¹⁾ Stresses beyond those listed under "absolute maximum ratings" may cause permanent damage to the device. These are stress ratings only, and functional operation of the device at these or any other conditions beyond those indicated under "recommended operating conditions" is not implied. Exposure to absolute-maximum-rated conditions for extended periods may affect device reliability.

⁽²⁾ The input negative-voltage and output voltage ratings may be exceeded if the input and output current ratings are observed.

⁽³⁾ The value of V_{CC} is provided in the recommended operating conditions table.



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Recommended Operating Conditions⁽¹⁾

			MIN	MAX	UNIT
\/	Cupply valtage	Operating	2	3.6	V
V _{CC}	Supply voltage	Data retention only	1.5		V
V _{IH}	High-level input voltage	V _{CC} = 2.7 V to 3.6 V	2		V
V _{IL}	Low-level input voltage	V _{CC} = 2.7 V to 3.6 V		0.8	V
VI	Input voltage		0	5.5	V
\/	Output voltage	High or low state	0	V _{CC}	V
Vo		3-state	0	5.5	V
	High level cutout current	V _{CC} = 2.7 V		-12	A
ІОН	High-level output current	V _{CC} = 3 V		-24	mA
	Laurent autout autout	V _{CC} = 2.7 V		12	Λ
I _{OL}	Low-level output current	V _{CC} = 3 V		24	mA
Δt/Δν	Input transition rise or fall rate			10	ns/V
T _A	Operating free-air temperature		-55	125	°C

All unused inputs of the device must be held at V_{CC} or GND to ensure proper device operation. Refer to the TI application report, *Implications of Slow or Floating CMOS Inputs*, literature number SCBA004.

Electrical Characteristics

over recommended operating free-air temperature range (unless otherwise noted)

P	ARAMETER	TEST CONDITION	ONS	V _{cc}	MIN	TYP ⁽¹⁾	MAX	UNIT			
		1004		1.65 V to 3.6 V							
		$I_{OH} = -100 \mu A$		2.7 V to 3.6 V	V _{CC} - 0.2						
V _{OH}		$I_{OH} = -4 \text{ mA}$									
		$I_{OH} = -8 \text{ mA}$		2.3 V				V			
		1. 10 mA		2.7 V	2.2						
		$I_{OH} = -12 \text{ mA}$		3 V	2.4						
	I _{OH} = -24 mA			3 V	2.2						
		1 400 4		1.65 V to 3.6 V							
	$I_{OL} = 100 \mu A$			2.7 V to 3.6 V			0.2				
.,		I _{OL} = 4 mA		1.65 V				V			
V _{OL}		I _{OL} = 8 mA		2.3 V				V			
V _{OL}	I _{OL} = 12 mA		2.7 V			0.4					
		I _{OL} = 24 mA		3 V			0.55				
I	Control inputs	V _I = 0 to 5.5 V		3.6 V			±5	μΑ			
I _{off}		V_I or $V_O = 5.5 \text{ V}$		0				μΑ			
$I_{OZ}^{(2)}$		V _O = 0 to 5.5 V		3.6 V			±15	μΑ			
		V _I = V _{CC} or GND	I _O = 0	2.6.1/			10	^			
I _{CC}		$3.6 \text{ V} \le \text{V}_1 \le 5.5 \text{ V}^{(3)}$		3.6 V			10	μΑ			
ΔI_{CC}		One input at V _{CC} – 0.6 V, Other inputs at V _{CC} or GND		2.7 V to 3.6 V			500	μΑ			
C _i	Control inputs	V _I = V _{CC} or GND		3.3 V		4.5		pF			
C _{io}	A or B port	$V_O = V_{CC}$ or GND		3.3 V		7.5		pF			

All typical values are at V $_{CC}=3.3$ V, T $_{A}=25^{\circ}C$. For I/O ports, the parameter I $_{OZ}$ includes the input leakage current. This applies in the disabled state only.



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Timing Requirements

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 2)

		V _{CC} = 2.7 V		V _{CC} = 3 ± 0.3	UNIT	
		MIN	MAX	MIN	MAX	
f _{clock}	Clock frequency		150		150	MHz
t _w	Pulse duration	3.3		3.3		ns
t _{su}	Setup time, data before CLK↑	1.6		1.5		ns
t _h	Hold time, data after CLK↑	1.7		1.7		ns

Switching Characteristics

over recommended operating free-air temperature range (unless otherwise noted) (see Figure 2)

PARAMETER	FROM	TO	V _{CC} = 2	2.7 V	V _{CC} = 3 ± 0.3	UNIT	
	(INPUT)	(OUTPUT)		MAX	MIN	MAX	
f _{max}			150		150		MHz
	A or B	B or A		7.9	1	7.4	
t _{pd}	CLK	A or B		8.8	1	8.4	ns
	SBA or SAB	AOIB		9.9	1	8.6	
t _{en}	ŌĒ	A		10.2	1	8.2	ns
t _{dis}	ŌĒ	A		8.9	1	7.5	ns
t _{en}	DIR	В		10.4	1	8.3	ns
t _{dis}	DIR	В		8.7	1	7.9	ns

Operating Characteristics

 $T_A = 25$ °C

	PARAMETER		TEST CONDITIONS	V _{CC} = 1.8 V	V_{CC} = 2.5 V	$V_{CC} = 3.3 \text{ V}$	UNIT	
				TYP	TYP	V V _{CC} = 3.3 V TYP 75 9		
Cnd	Power dissipation capacitance	Outputs enabled	f = 10 MHz	(1)	(1)	75	PF	
Cpd	per transceiver	Outputs disabled	I = IU IVIMZ	(1)	(1)	9	рΓ	

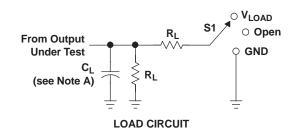
⁽¹⁾ This information was not available at the time of publication.

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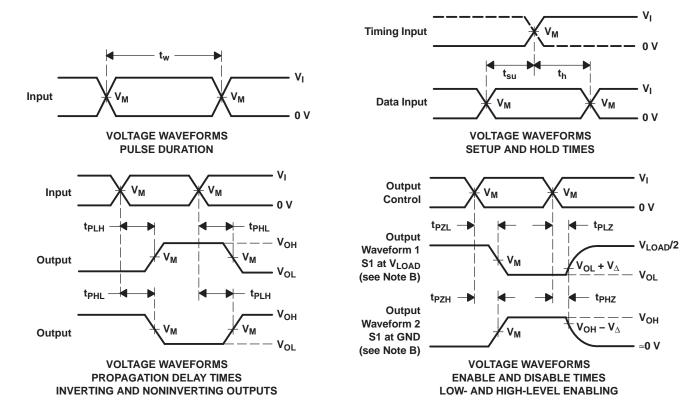
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PARAMETER MEASUREMENT INFORMATION



TEST	S1
t _{PLH} /t _{PHL}	Open
t _{PLZ} /t _{PZL}	V _{LOAD}
t _{PHZ} /t _{PZH}	GND

V	INF	PUTS	V	V		Б	V
V _{CC}	V_{I}	t _r /t _f	V _M	V _{LOAD}	CL	R _L	$V_{\!\scriptscriptstyle \Delta}$
1.8 V ± 0.15 V	V _{CC}	≤2 ns	V _{CC} /2	2×V _{CC}	30 pF	1 k Ω	0.15 V
2.5 V \pm 0.2 V	Vcc	≤2 ns	V _{CC} /2	2×V _{CC}	30 pF	500 Ω	0.15 V
2.7 V	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	500 Ω	0.3 V
3.3 V \pm 0.3 V	2.7 V	≤2.5 ns	1.5 V	6 V	50 pF	500 Ω	0.3 V



NOTES: A. C_L includes probe and jig capacitance.

- B. Waveform 1 is for an output with internal conditions such that the output is low, except when disabled by the output control. Waveform 2 is for an output with internal conditions such that the output is high, except when disabled by the output control.
- C. All input pulses are supplied by generators having the following characteristics: PRR \leq 10 MHz, Z_O = 50 Ω .
- D. The outputs are measured one at a time, with one transition per measurement.
- E. t_{PLZ} and t_{PHZ} are the same as t_{dis} .
- F. t_{PZL} and t_{PZH} are the same as t_{en} .
- G. t_{PLH} and t_{PHL} are the same as t_{pd} .
- H. All parameters and waveforms are not applicable to all devices.

Figure 2. Load Circuit and Voltage Waveforms

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PACKAGING INFORMATION

Orderable Device	Status (1)	Package Type	Package Drawing	Pins	Package Qty	Eco Plan	Lead finish/ Ball material	MSL Peak Temp	Op Temp (°C)	Device Marking (4/5)	Samples
5962-9762601VKA	ACTIVE	CFP	W	24	25	Non-RoHS & Green	SNPB	N / A for Pkg Type	-55 to 125	5962-9762601VK A SNV54LVC646AW	Samples

(1) The marketing status values are defined as follows:

ACTIVE: Product device recommended for new designs.

LIFEBUY: TI has announced that the device will be discontinued, and a lifetime-buy period is in effect.

NRND: Not recommended for new designs. Device is in production to support existing customers, but TI does not recommend using this part in a new design.

PREVIEW: Device has been announced but is not in production. Samples may or may not be available.

OBSOLETE: TI has discontinued the production of the device.

(2) RoHS: TI defines "RoHS" to mean semiconductor products that are compliant with the current EU RoHS requirements for all 10 RoHS substances, including the requirement that RoHS substance do not exceed 0.1% by weight in homogeneous materials. Where designed to be soldered at high temperatures, "RoHS" products are suitable for use in specified lead-free processes. TI may reference these types of products as "Pb-Free".

RoHS Exempt: TI defines "RoHS Exempt" to mean products that contain lead but are compliant with EU RoHS pursuant to a specific EU RoHS exemption.

Green: TI defines "Green" to mean the content of Chlorine (CI) and Bromine (Br) based flame retardants meet JS709B low halogen requirements of <=1000ppm threshold. Antimony trioxide based flame retardants must also meet the <=1000ppm threshold requirement.

- (3) MSL, Peak Temp. The Moisture Sensitivity Level rating according to the JEDEC industry standard classifications, and peak solder temperature.
- (4) There may be additional marking, which relates to the logo, the lot trace code information, or the environmental category on the device.
- (5) Multiple Device Markings will be inside parentheses. Only one Device Marking contained in parentheses and separated by a "~" will appear on a device. If a line is indented then it is a continuation of the previous line and the two combined represent the entire Device Marking for that device.
- (6) Lead finish/Ball material Orderable Devices may have multiple material finish options. Finish options are separated by a vertical ruled line. Lead finish/Ball material values may wrap to two lines if the finish value exceeds the maximum column width.

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TUBE

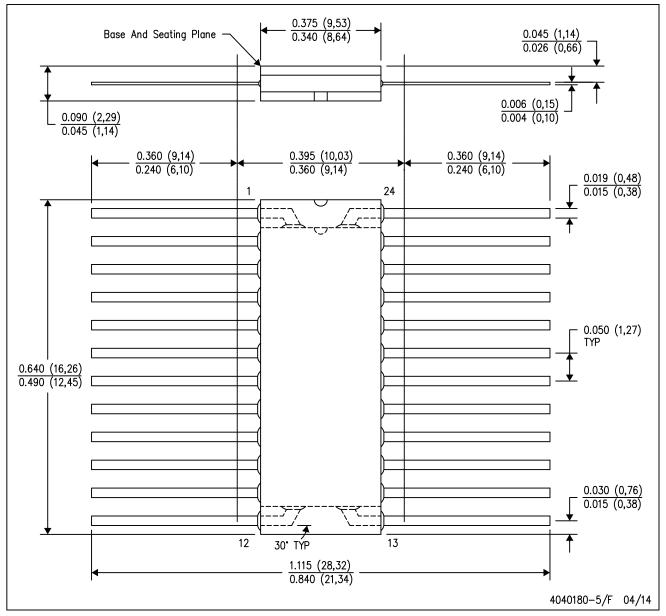


*All dimensions are nominal

Device	Package Name	Package Type	Pins	SPQ	L (mm)	W (mm)	T (µm)	B (mm)
5962-9762601VKA	W	CFP	24	25	506.98	26.16	6220	NA

W (R-GDFP-F24)

CERAMIC DUAL FLATPACK



NOTES:

- A. All linear dimensions are in inches (millimeters).
- This drawing is subject to change without notice.
- C. This package can be hermetically sealed with a ceramic lid using glass frit.
- D. Index point is provided on cap for terminal identification only. E. Falls within Mil—Std 1835 GDFP2—F20



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